# Product Change Notification - JAON-22CDLC928

Date: 06 Jul 2017

**Product Category:** Interface- Serial Peripherals; 8-bit PIC Microcontrollers

**Notification subject:** CCB 3000 Initial Notice: Qualification of MMT as an additional assembly site using CuPdAu bond

wire in selected products of the 150K and 160K wafer technologies available in 28L SSOP package.

**PCN Status: Notification text:** 

Initial notification

#### **Microchip Parts Affected:**

Please open the attachments found in the attachments field below labeled as PCN\_#\_Affected\_CPN.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

### **Description of Change:**

Qualification of MMT as an additional assembly site using palladium coated copper with gold flash (CuPdAu) bond wire in selected products of the 150K and 160K wafer technologies available in 28L SSOP package.

#### Pre Change:

Assembled at MTAI using palladium coated copper (PdCu) bond wire.

### **Post Change:**

Assembled at MTAI using palladium coated copper (PdCu) bond wire or assembled at MMT using palladium coated copper with gold flash (CuPdAu) bond wire.

#### **Pre and Post Change Summary:**

	Pre Change	Post Change			
Assembly Site	MTAI Assembly Site	MTAI Assembly Site	MMT Assembly Site		
Wire material	PdCu Wire	PdCu Wire	CuPdAu Wire		
Die attach material	3280	3280	3280		
Molding compound material	G600	G600	G600		
Lead frame material	CDA194	CDA194	CDA194		

# Impacts to Data Sheet:

None

### **Change Impact:**

None

### **Reason for Change:**

To improve productivity by qualifying MMT as an additional assembly site using palladium coated copper with gold flash (CuPdAu) bond wire.

# **Change Implementation Status:**

In Progress

### **Estimated Qualification Completion Date:**

October 2017

Note: Please be advised the qualification completion times may be extended because of unforeseen business conditions however implementation will not occur until after qualification has completed and a final PCN has been issued. The final PCN will include the qualification report and estimated first ship date. Also note that after the estimated first ship date guided in the final PCN customers may receive pre and post change parts.

### **Time Table Summary:**

	July 2017			>	October 2017				
Workweek	27	28	29	30		40	41	42	43
Initial PCN Issue Date	Χ								
Qual Report Availability								X	
Final PCN Issue Date								Х	

#### Method to Identify Change:

Traceability code

### Qualification Plan:

Please open the attachments included with this PCN labeled as PCN\_#\_Qual Plan

#### **Revision History:**

July 6, 2017: Issued initial notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s): PCN\_JAON-22CDLC928\_Qual Plan.pdf

PCN\_JAON-22CDLC928\_Affected CPN.pdf PCN\_JAON-22CDLC928\_Affected CPN.xlsx

Please contact your local Microchip sales office with questions or concerns regarding this notification.

#### **Terms and Conditions:**

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To opt out of future offer or information emails (other than product change notification emails), click here to go to microchipDIRECT and login, then click on the "My account" link, click on "Update profile" and un-check the box that states "Future offers or information about Microchip's products or services."

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Affected Catalog Part Numbers (CPN)

PCN_JAON-22CDLC928
CATALOG_PART_NBR
HA1930-I/SS
HA1930T-I/SS
HA4315T-I/SS
HA4315T-I/SS022
MCP23016-I/SS
MCP23016T-I/SS
MCP23017-E/SS
MCP23017T-E/SS
MCP23S17-E/SS
MCP23S17T-E/SS
PIC16F570-E/SS
PIC16F570-I/SS
PIC16F570T-I/SS
PIC16F57-E/SS
PIC16F57-I/SS
PIC16F57T-E/SS
PIC16F57T-I/SS
PIC16F57T-I/SS024
PIC16F57T-I/SS025
PIC16F57T-I/SS027
PIC16F72-E/SS
PIC16F72-I/SS
PIC16F72T-E/SS
PIC16F72T-I/SS
PIC16F737-I/SS
PIC16F737T-I/SS
PIC16F73-E/SS
PIC16F73-I/SS
PIC16F73T-E/SS
PIC16F73T-I/SS
PIC16F73T-I/SS155
PIC16F73T-I/SSC15
PIC16F767-E/SS
PIC16F767-I/SS
PIC16F767T-I/SS
PIC16F76-E/SS
PIC16F76-I/SS
PIC16F76T-E/SS
PIC16F76T-I/SS
PIC16F873A-E/SS
PIC16F873A-I/SS
PIC16F873AT-I/SS
PIC16F876A-E/SS
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Affected Catalog Part Numbers (CPN)

PCN_JAON-22CDLC928
CATALOG_PART_NBR
PIC16F876A-I/SS
PIC16F876AT-E/SS
PIC16F876AT-I/SS
PIC16F876AT-I/SSC36
PIC16F882-E/SS
PIC16F882-I/SS
PIC16F882T-E/SS
PIC16F882T-I/SS
PIC16F883-E/SS
PIC16F883-I/SS
PIC16F883-I/SS046
PIC16F883-I/SS063
PIC16F883-I/SS064
PIC16F883T-E/SS
PIC16F883T-I/SS
PIC16F883T-I/SS022
PIC16F883T-I/SS063
PIC16F883T-I/SS064
PIC16F883T-I/SS070
PIC16F883T-I/SS071
PIC16F886-E/SS
PIC16F886-I/SS
PIC16F886T-E/SS
PIC16F886T-I/SS
PIC16F886T-I/SS026
PIC16F886T-I/SS052
PIC16F886T-I/SS056
PIC16F886T-I/SSC07
PIC16F913-E/SS
PIC16F913-I/SS
PIC16F913T-E/SS
PIC16F913T-I/SS
PIC16F913T-I/SS025
PIC16F913T-I/SS027
PIC16F913T-I/SS032
PIC16F916-E/SS
PIC16F916-I/SS
PIC16F916-I/SS034
PIC16F916-I/SS035
PIC16F916T-I/SS
PIC16F916T-I/SS028
PIC16F916T-I/SS029
PIC16F916T-I/SS031
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Affected Catalog Part Numbers (CPN)

PCN_JAON-22CDLC928			
CATALOG_PART_NBR			
PIC16F916T-I/SS033			
PIC16F916T-I/SS034			
PIC16F916T-I/SS035			
PIC16LF72-I/SS			
PIC16LF72T-I/SS			
PIC16LF737-I/SS			
PIC16LF737T-I/SS			
PIC16LF737T-I/SS021			
PIC16LF73-I/SS			
PIC16LF73T-I/SS			
PIC16LF767-I/SS			
PIC16LF767T-I/SS			
PIC16LF76-I/SS			
PIC16LF76T-I/SS			
PIC16LF873A-I/SS			
PIC16LF873AT-I/SS			
PIC16LF876A-I/SS			
PIC16LF876AT-I/SS			
PIC16LF876AT-I/SSC26			
PIC18F2221-E/SS			
PIC18F2221-I/SS			
PIC18F2221T-I/SS			
PIC18F2321-E/SS			
PIC18F2321-I/SS			
PIC18F2321T-E/SS			
PIC18LF2221-I/SS			
PIC18LF2221T-I/SS			
PIC18LF2321-I/SS			
PIC18LF2321T-I/SS			
PS501-I/SSC05			
PS501T-I/SSC01			
PS501T-I/SSC05			